

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C ⁽¹⁾		STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C ⁽²⁾
	VOLTAGE	100 V AC		STORAGE HUMIDITY RANGE	40 % TO 70 % ⁽²⁾
	CURRENT	0.5 A (SIGNAL CONTACT) ⁽³⁾ 3 A (MF CONTACT)		OPERATING HUMIDITY RANGE	RELATIVE HUMIDITY 85% max (NOT DEWED)
SPECIFICATIONS					
ITEM		TEST METHOD		REQUIREMENTS	
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	
MARKING		CONFIRMED VISUALLY.			
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100 mA(DC OR 1000Hz)		SIGNAL CONTACT : 90 mΩ MAX. MF CONTACT : 30 mΩ MAX.	x —
INSULATION RESISTANCE		250 V DC.		1000 MΩ MIN.	x —
VOLTAGE PROOF		300 V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	x —
MECHANICAL CHARACTERISTICS					
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.		INSERTION FORCE: 80 N MAX. WITHDRAWAL FORCE: 8 N MIN.	x —
MECHANICAL OPERATION		500 TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x —
VIBRATION		FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x —
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			x —
ENVIRONMENTAL CHARACTERISTICS					
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.		① CONTACT RESISTANCE: SIGNAL CONTACT : 100 mΩ MAX. MF CONTACT : 40 mΩ MAX.	x —
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 → +85 °C TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER: WITHIN 2~3 MIN)		② INSULATION RESISTANCE :1000 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x —
SULFUR DIOXIDE		EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)		NO HEAVY CORROSION.	x —
RESISTANCE TO SOLDERING HEAT		1)REFLOW SOLDERING : PEAK TMP : 260°C MAX REFLOW TMP: 220°C MIN FOR 60sec 2) SOLDERING IRONS : 360°C MAX. FOR 5 sec.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.	x —
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.		A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	x —
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△					
REMARKS ⁽¹⁾ INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. ⁽²⁾ *STORAGE* MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB. ⁽³⁾ THE RATED CURRENT APPLIES TO PER CONTACT. APPLY 0.4A WHEN ALL THE CONTACTS ARE USED FOR CURRENT CARRYING. Unless otherwise specified, refer to JIS-C-5402.			APPROVED	HS. OKAWA	11. 03. 24
			CHECKED	K.I. HIROKAWA	11. 03. 24
			DESIGNED	TH. SANO	11. 03. 24
			DRAWN	TH. SANO	11. 03. 24
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-159079-00
HRS	SPECIFICATION SHEET		PART NO.	FX18-140P-0. 8SH	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL579-0007-9-00	△ 1/1